SUM90100E

Vishay Siliconix



N-Channel 200 V (D-S) MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	200				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.0114				
$R_{DS(on)}$ max. (Ω) at V_{GS} = 7.5 V	0.0129				
Q _g typ. (nC)	56.7				
I _D (A)	150 ^d				
Configuration	Single				

FEATURES

- TrenchFET[®] power MOSFET
- Maximum 175 °C junction temperature
- Very low Q_{gd} reduces power loss from passing through $V_{plateau}$
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Switching power supply
- DC/DC converter
- Power tools
- Motor drive switch
- DC/AC inverter
- Battery management
- OR-ing / e-fuse

N-Channel MOSFET

ORDERING INFORMATION	
Package	TO-263
Lead (Pb)-free and halogen-free	SUM90100E-GE3

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	200	v	
Gate-source voltage		V _{GS}	± 20	v	
Orationary during summer (T 150 °C)	T _C = 25 °C		150 ^d		
Continuous drain current (T _J = 150 °C)	T _C = 70 °C		150 ^d	А	
Pulsed drain current (t = 100 µs)		I _{DM}	250		
Avalanche current		I _{AS}	70		
Single avalanche energy ^a	L = 0.1 mH	E _{AS}	245	mJ	
	T _C = 25 °C	D-	375 ^b	w	
Maximum power dissipation ^a	T _C = 125 °C	P _D	125 ^b	~ ~ ~	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	LIMIT	UNIT	
Junction-to-ambient (PCB mount) ^c	R _{thJA}	40	- °C/W	
Junction-to-case (drain)	R _{thJC}	0.4		

Notes

a. Duty cycle ≤ 1 %

b. See SOA curve for voltage derating

c. When mounted on 1" square PCB (FR4 material)

d. Package limited

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RoHS COMPLIANT

HALOGEN

FREE

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	$V_{GS}=0~V,~I_D=250~\mu A$	200	-	-	V
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2	-	4	v
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	± 250	nA
Zero gate voltage drain current		$V_{DS} = 200 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	1	
	I _{DSS}	V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 125 °C	-	-	150	μA
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 175 °C	-	-	5	mA
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120	-	-	А
Drain-source on-state resistance ^a	_	V _{GS} = 10 V, I _D = 16 A	-	0.0095	0.0114	Ω
	R _{DS(on)}	V_{GS} = 7.5 V, I_{D} = 13 A	-	0.0099	0.0129	
Forward transconductance a	g _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 13 \text{ A}$	-	85	-	S
Dynamic ^b	-			1		
Input capacitance	C _{iss}		-	3930	-	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 100 V, f = 1 MHz$	-	450	-	
Reverse transfer capacitance	C _{rss}		-	12	-	
Total gate charge ^c	Qg		-	72.8	110	
Gate-source charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 16 \text{ A}$	-	19.4	-	nC
Gate-drain charge ^c	Q _{gd}		-	19.0	-	
Gate resistance	Rg	f = 1 MHz	0.7	3.5	7.0	Ω
Turn-on delay time ^c	t _{d(on)}		-	20	40	
Rise time ^c	t _r	$V_{DD} = 80 \text{ V}, \text{ R}_{L} = 6.2 \Omega$	-	50	100	
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 13$ A, $V_{GEN} = 10$ V, $R_g = 1$ Ω	-	60	120	ns
Fall time ^c	t _f		-	18	36	
Drain-Source Body Diode Ratings	and Characte	ristics ^b (T _C = 25 °C)				
Pulsed current (t = 100 µs)	I _{SM}		-	-	250	А
Forward voltage a	V _{SD}	I _F = 10 A, V _{GS} = 0 V	-	0.8	1.5	V
Reverse recovery time	t _{rr}		-	118	177	ns
Peak reverse recovery charge	I _{RM(REC)}		-	9.4	14.1	А
Reverse recovery charge	Q _{rr}	I _F = 13 A, di/dt = 100 A/μs	-	0.632	0.948	μC
Reverse recovery fall time	ta		-	94	-	
Reverse recovery rise time	t _b		-	24	-	ns

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

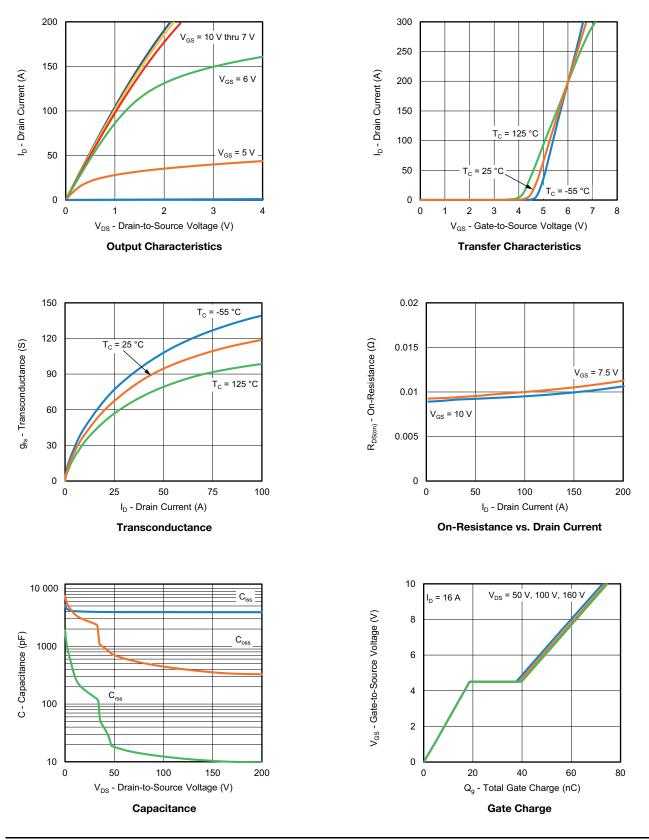
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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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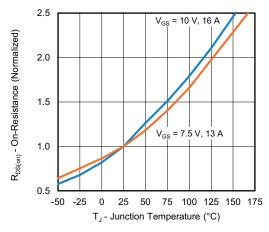
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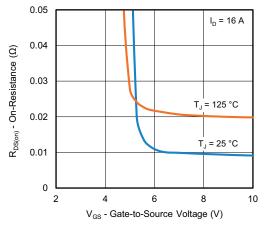
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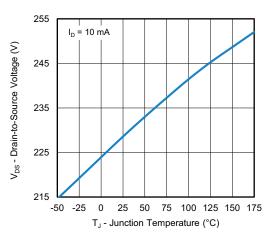
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



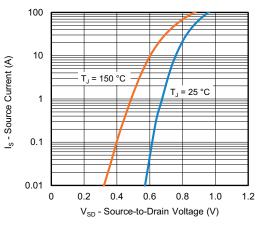
On-Resistance vs. Junction Temperature



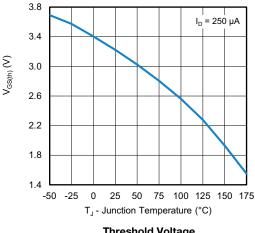
On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



Threshold Voltage

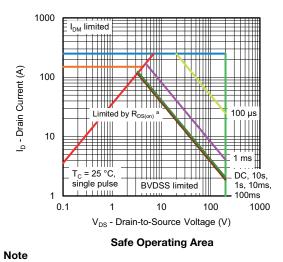
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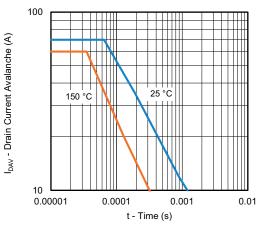
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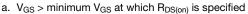
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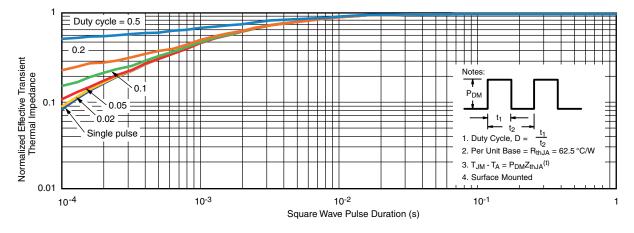
THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)





Single Pulse Avalanche Current Capability vs. Time





Normalized Thermal Transient Impedance, Junction-to-Case

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TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



		INCHES		MILLIN	IETERS
DIM.		MIN.	MAX.	MIN.	MAX.
А		0.160	0.190	4.064	4.826
	b	0.020	0.039	0.508	0.990
	b1	0.020	0.035	0.508	0.889
	b2	0.045	0.055	1.143	1.397
с*	Thin lead	0.013	0.018	0.330	0.457
C	Thick lead	0.023	0.028	0.584	0.711
c1	Thin lead	0.013	0.017	0.330	0.431
CI	Thick lead	0.023	0.027	0.584	0.685
	c2	0.045	0.055	1.143	1.397
	D	0.340	0.380	8.636	9.652
	D1	0.220	0.240	5.588	6.096
	D2	0.038	0.042	0.965	1.067
	D3	0.045	0.055	1.143	1.397
	D4	0.044	0.052	1.118	1.321
	E	0.380	0.410	9.652	10.414
	E1	0.245	-	6.223	-
	E2	0.355	0.375	9.017	9.525
	E3	0.072	0.078	1.829	1.981
	е	0.100 BSC		2.54 BSC	
	К	0.045	0.055	1.143	1.397
L		0.575	0.625	14.605	15.875
	L1	0.090	0.110	2.286	2.794
L2		0.040	0.055	1.016	1.397
L3		0.050	0.070	1.270	1.778
L4 0.		0.010) BSC	0.254 BSC	
М		-	0.002	-	0.050
ECN: T13-0707-Rev. K, 30-Sep-13 DWG: 5843					

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic. 2. No more than 25 % of L1 can fall above seating plane by
- max. 8 mils.3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
 - Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

This feature is for thick lead.

Revison: 30-Sep-13



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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